

New Product

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	(Ω) I _D (A)			
-60	0.064 @ V _{GS} = -10 V	- 5	26		
	0.080 @ V _{GS} = -4.5 V	-4.5	20		

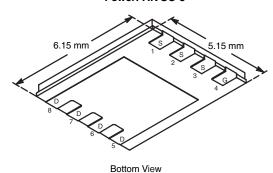
FEATURES

- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile

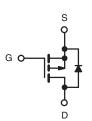


COMPLIANT

PowerPAK SO-8



Ordering Information: Si7465DP-T1—E3 (Lead (Pb)-Free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $ op$	A = 25 °C, unles	ss otherwise r	noted		
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	-60		V
Gate-Source Voltage		V _{GS}	±20		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	- 5	-3.2	
Continuous Diain Current (1) = 150 C)	T _A = 70°C		-4	-2.6	
Pulsed Drain Current		I _{DM}	-25		Α
Continuous Source Current (Diode Conduction) ^a		I _S	-2.9	-1.2	
Avalanche Current	L = 0.1 mH	I _{AS}	22		
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	24.2		mJ
Marrian na Barras Biaria di ang	T _A = 25°C	P _D	3.5	1.5	W
Maximum Power Dissipation ^a	T _A = 70°C	' D	2.2	0.94	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C
Soldering Recommendations (Peak Temperature)b,c			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum lunction to Ambienta	t ≤ 10 sec	R _{thJA}	27	36	°C/W
Maximum Junction-to-Ambient ^a	Steady State		60	85	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	3.3	4.3	

Notes
a. Surface Mounted on 1" x 1" FR4 Board.
b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

Pewerk Conditions: manual soldering with a soldering iron is not recommended for leadless components.

Document Number: 73113 S-51566-Rev. B, 07-Nov-05

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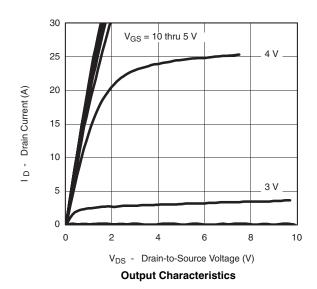


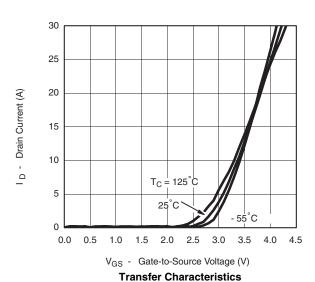
SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$, unless otherwise noted								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.0		-3.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA		
Zana Oaka Valla va Busia Oamaal	lass	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			-1			
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$			-10	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-25			Α		
	r	$V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$		0.051	0.064	0		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -4.5 \text{ A}$	A 0.064 0.080		0.080	Ω		
Forward Transconductance ^a	g _{fs}	$V_{DS} = -15 \text{ V}, I_{D} = -5 \text{ A}$		16		S		
Diode Forward Voltage ^a	V_{SD}	$I_S = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V		
Dynamic ^b	<u>'</u>			1				
Total Gate Charge	Q_g			26	40	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$		4.5				
Gate-Drain Charge	Q_{gd}			7.0				
Gate Resistance	R_{g}			7.0		Ω		
Turn-On Delay Time	t _{d(on)}			8	15			
Rise Time	t _r	V_{DD} = -30 V, R_L = 30 Ω		9	15			
Turn-Off Delay Time	t _{d(off)}	$I_D\cong -1.0$ A, $V_{GEN}=-10$ V, $R_G=6~\Omega$		65	100	ns		
Fall Time	t _f			30	45			
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		41	70			

- Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted

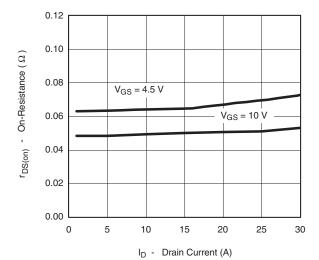


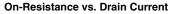


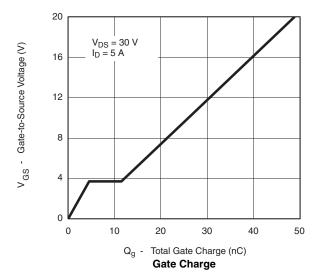


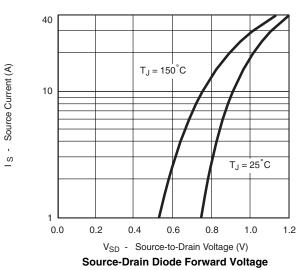
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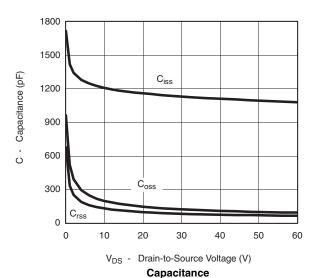
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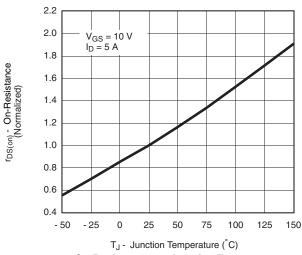




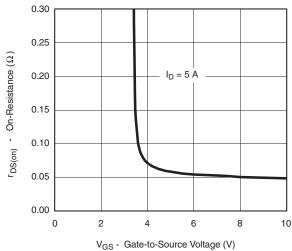








On-Resistance vs. Junction Temperature



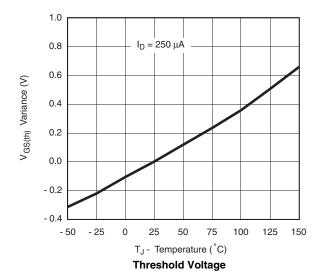
On-Resistance vs. Gate-to-Source Voltage

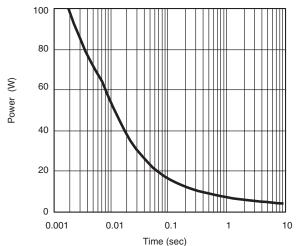
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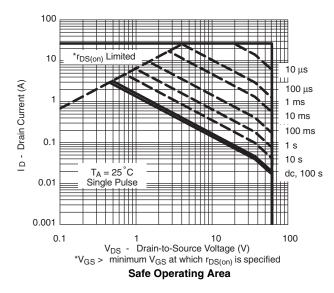


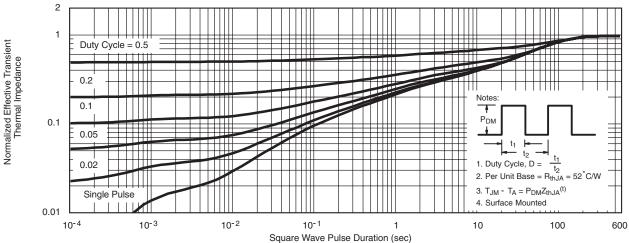
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Single Pulse Power, Junction-to-Ambient

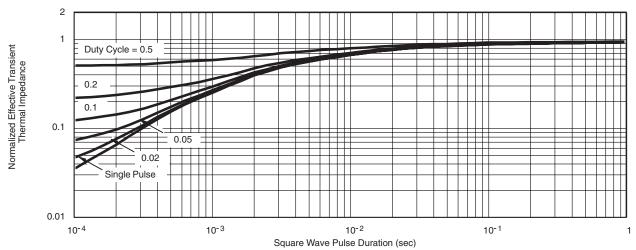




Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73113.

Document Number: 73113 S-51566-Rev. B, 07-Nov-05

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Document Number: 91000 www.vishay.com
Revision: 08-Apr-05 1